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# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









## Standard SMD LED PLCC-2



# DESCRIPTION

These devices have been designed to meet the increasing demand for surface mounting technology.

The package of the TLMS310. is the PLCC-2 (equivalent to a size B tantalum capacitor).

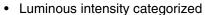
It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear epoxy.

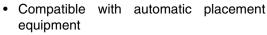
#### PRODUCT GROUP AND PACKAGE DATA

Product group: LED
Package: SMD PLCC-2
Product series: standard
Angle of half intensity: ± 60°

#### **FEATURES**

• SMD LEDs with exceptional brightness







- · EIA and ICE standard package
- Compatible with infrared, vapor phase and wave solder processes according to CECC
- · Available in 8 mm tape
- · Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- · Low power consumption
- Luminous intensity ratio in one packaging unit  $I_{Vmax}/I_{Vmin} \le 2.0$ , optional  $\le 1.6$
- Lead (Pb)-free device

#### **APPLICATIONS**

- Automotive: backlighting in dashboards and switches
- Telecommunication: indicator and backlighting in telephone and fax
- Indicator and backlight for audio and video equipment
- · Indicator and backlight in office equipment
- Flat backlight for LCDs, switches and symbols

PARTS TABLE					
PART	COLOR, LUMINOUS INTENSITY	TECHNOLOGY			
TLMS3100-GS08	Red, I <sub>V</sub> > 2.5 mcd	GaAsP on GaP			
TLMS3100-GS18	Red, I <sub>V</sub> > 2.5 mcd	GaAsP on GaP			
TLMS3101-GS08	Red, I <sub>V</sub> = (4 to 12.5) mcd	GaAsP on GaP			
TLMS3101-GS18	Red, I <sub>V</sub> = (4 to 12.5) mcd	GaAsP on GaP			



ABSOLUTE MAXIMUM RATINGS <sup>1)</sup> TLMS310.							
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT			
Reverse voltage		V <sub>R</sub>	6	V			
DC Forward current	T <sub>amb</sub> ≤ 60 °C	I <sub>F</sub>	30	mA			
Surge forward current	t <sub>p</sub> ≤ 10 μs	I <sub>FSM</sub>	0.5	Α			
Power dissipation	T <sub>amb</sub> ≤ 60 °C	P <sub>V</sub>	100	mW			
Junction temperature		Tj	100	°C			
Operating temperature range		T <sub>amb</sub>	- 40 to + 100	°C			
Storage temperature range		T <sub>stg</sub>	- 40 to + 100	°C			
Soldering temperature	t ≤ 5 s	T <sub>sd</sub>	260	°C			
Thermal resistance junction/ ambient	mounted on PC board (pad size > 16 mm <sup>2</sup> )	R <sub>thJA</sub>	400	K/W			

 $<sup>^{1)}</sup>$  T<sub>amb</sub> = 25 °C, unless otherwise specified

PARAMETER	TEST CONDITION	PART	SYMBOL	MIN	TYP.	MAX	UNIT
Luminous intensity <sup>2)</sup>	I <sub>F</sub> = 10 mA	TLMS3100	Ι <sub>V</sub>	2.5	7.5		
		TLMS3101	Ι <sub>V</sub>	4		12.5	mcd
Dominant wavelength	I <sub>F</sub> = 10 mA		$\lambda_{d}$	624		636	nm
Peak wavelength	I <sub>F</sub> = 10 mA		$\lambda_{p}$		640		nm
Angle of half intensity	I <sub>F</sub> = 10 mA		φ		± 60		deg
Forward voltage	I <sub>F</sub> = 20 mA		$V_{F}$		2.0	2.6	V
Reverse voltage	I <sub>R</sub> = 10 μA		$V_{R}$	6			V
Junction capacitance	V <sub>R</sub> = 0, f = 1 MHz		C <sub>j</sub>		7.0		pF
Temperature coefficient of V <sub>F</sub>	I <sub>F</sub> = 20 mA		TC <sub>VF</sub>		- 1.8		mV/K
Temperature coefficient of $\lambda_d$	I <sub>F</sub> = 10 mA		TCλ <sub>d</sub>		0.05		nm/K

### **TYPICAL CHARACTERISTICS**

T<sub>amb</sub> = 25 °C, unless otherwise specified

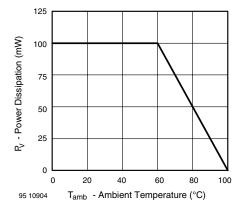


Figure 1. Power Dissipation vs. Ambient Temperature

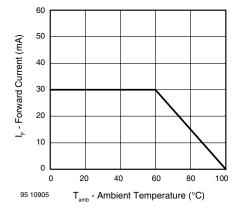


Figure 2. Forward Current vs. Ambient Temperature for InGaN

<sup>&</sup>lt;sup>1)</sup>  $T_{amb}$  = 25 °C, unless otherwise specified <sup>2)</sup> in one packing unit  $I_{Vmax}/I_{Vmin} \le 1.6$ 





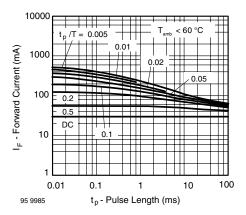


Figure 3. Pulse Forward Current vs. Pulse Duration

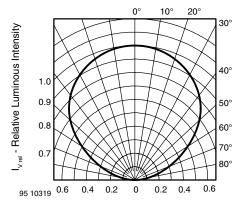


Figure 4. Rel. Luminous Intensity vs. Angular Displacement

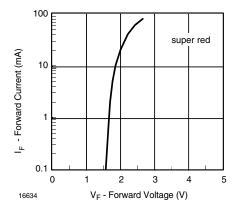


Figure 5. Forward Current vs. Forward Voltage

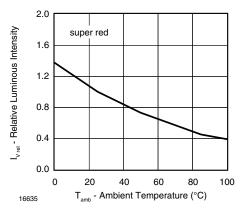


Figure 6. Rel. Luminous Intensity vs. Ambient Temperature

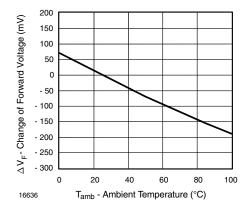


Figure 7. Change of Forward Voltage vs. Ambient Temperature

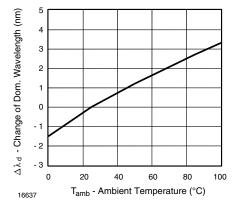


Figure 8. Change of Dominant Wavelength vs.
Ambient Temperature



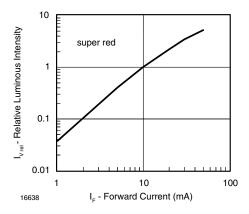


Figure 9. Relative Luminous Intensity vs. Forward Current

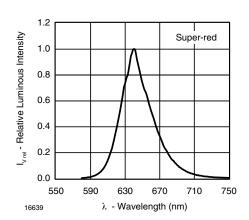
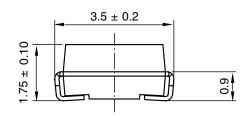
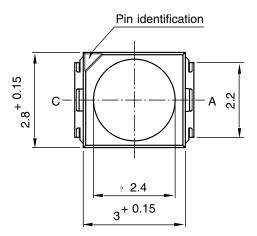


Figure 10. Relative Intensity vs. Wavelength

#### **PACKAGE DIMENSIONS** in millimeters





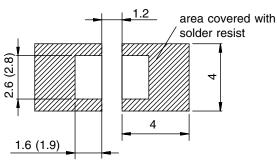


## Drawing-No.: 6.541-5025.01-4

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# Mounting Pad Layout





#### **Ozone Depleting Substances Policy Statement**

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany



Vishay

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